SQS164ELNW

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Vishay Siliconix

Automotive N-Channel 60 V (D-S) 175 °C MOSFET



Marking code: Q057

PRODUCT SUMMARY				
V _{DS} (V)	60			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 4.5 V$	0.0108			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.0069			
I _D (A)	82			
Configuration	Single			
Package	PowerPAK 1212-8SLW			

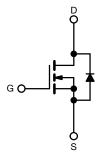
FEATURES

- TrenchFET[®] Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % R_g and UIS tested
- Wettable flank terminals
- Low thermal resistance with 0.75 mm profile



FREE

 Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	60	V	
Gate-source voltage		V _{GS}	± 20	v	
Continuous drain current	T _C = 25 °C	I_	82		
	T _C = 125 °C	ID	47		
Continuous source current (diode conduction)		I _S	94	А	
Pulsed drain current ^a		I _{DM}	192		
Single pulse avalanche current	L _ 0.1 mH	L = 0.1 mH			
Single pulse avalanche energy	L = 0.1 IIIH	E _{AS}	22	mJ	
Maximum power dissipation ^a	T _C = 25 °C	D-	104	W	
	T _C = 125 °C	PD	35	vv	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	- °C	
Soldering recommendations (peak temperature) ^c			260		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount ^b	R _{thJA}	81	°C/W	
Junction-to-case (drain)			1.44	C/VV	

Notes

- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. When mounted on 1" square PCB (FR4 material)

c. See solder profile (<u>www.vishay.com/doc?73257</u>). A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS}=0,I_D=250\;\mu A$		60	-	-	v
Gate-source threshold voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=250\;\mu A$		1.5	2.0	2.5	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	-	± 100	nA
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 60 V	-	-	1	μA
		$V_{GS} = 0 V$	$V_{DS} = 60 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	50	
		$V_{GS} = 0 V$	V _{DS} = 60 V, T _J = 175 °C	-	-	150	
On-state drain current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	20	-	-	Α
		V _{GS} = 4.5 V	1 10 1	-	0.0082	0.0108	Ω
	-	V _{GS} = 10 V	I _D = 10 A	-	0.00564	0.0069	
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 10 V	I _D = 10 A, T _J = 125 °C	-	-	0.0124	
		V _{GS} = 10 V	I _D = 10 A, T _J = 175 °C	-	-	0.0152	
Forward transconductance b	g _{fs}	V _{DS}	= 15 V, I _D = 20 A	-	70	-	S
Dynamic ^b		1			1		
Input capacitance	C _{iss}		V _{DS} = 25 V, f = 1 MHz	-	1542	2159	pF
Output capacitance	C _{oss}	V _{GS} = 0 V		-	539	755	
Reverse transfer capacitance	C _{rss}			-	40	56	
Total gate charge ^c	Qg		V _{GS} = 10 V V _{DS} = 30 V, I _D = 3 A	-	27	41	nC
Gate-source charge ^c	Q _{gs}	V _{GS} = 10 V		-	5	-	
Gate-drain charge ^c	Q _{gd}			-	5	-	
Gate resistance	Rg		f = 1 MHz	0.5	1.0	1.5	Ω
Turn-on delay time ^c	t _{d(on)}			-	10	15	
Rise time ^c	t _r	$\label{eq:VDD} \begin{array}{l} V_{DD} = 30 \ V, \ R_{L} = 6.67 \ \Omega \\ I_{D} \cong 3 \ A, \ V_{GEN} = 10 \ V, \ R_{g} = 10 \ \Omega \end{array}$		-	4	8	- ns
Turn-off delay time ^c	t _{d(off)}			-	22	33	
Fall time ^c	t _f			-	8	12	
Source-Drain Diode Ratings and Charac	teristic ^b				1		
Pulsed current ^a	I _{SM}	1		-	-	192	А
Forward voltage	V _{SD}	I _F = 10 A, V _{GS} = 0 V		-	0.82	1.1	V
Body diode reverse recovery time	t _{rr}	V _{DD} = 48 V, I _{FM} = 3 A, di/dt = 100 A/μs, R = 10 Ω, L = 0.3 mH, pulse width = 2 μs		-	26	52	ns
Body diode reverse recovery charge	Q _{rr}			-	16	32	nC
Reverse recovery fall time	t _a			-	12	-	
Reverse recovery rise time	t _b			-	14	-	ns
Body diode peak reverse recovery current	I _{RM(REC)}			-	-1.1	_	А

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

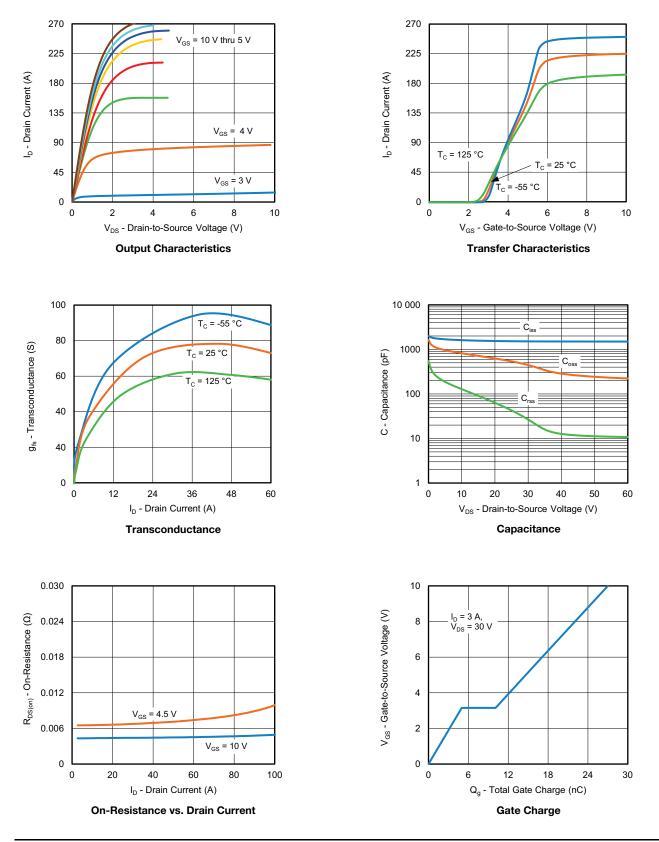
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



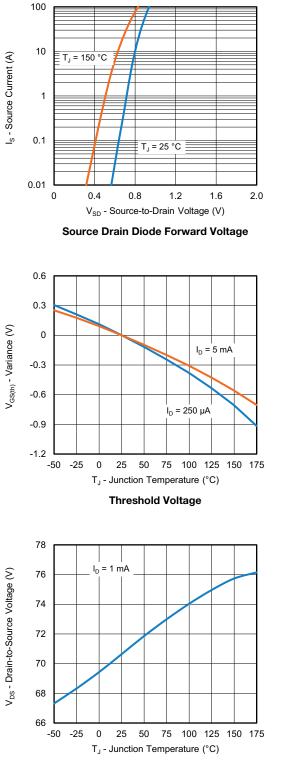
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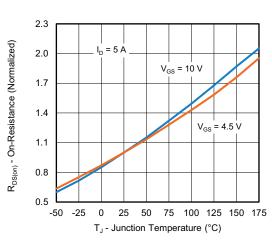


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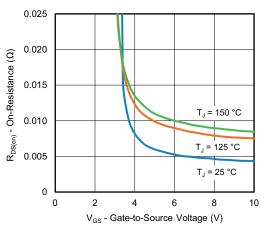
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



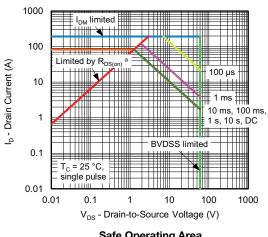
Drain Source Breakdown vs. Junction Temperature



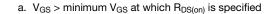
On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



Safe Operating Area



S23-0706-Rev. C, 04-Sep-2023

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Note

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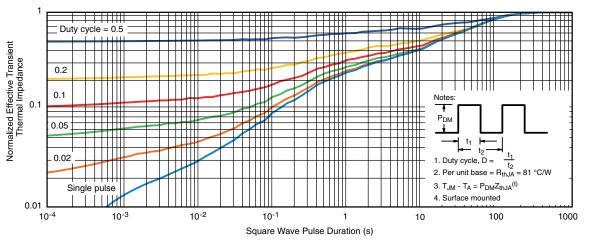
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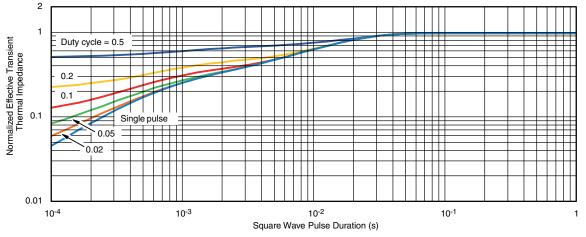


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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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RECOMMENDED MINIMUM PADS FOR PowerPAK[®] 1212-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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